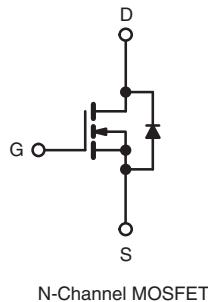
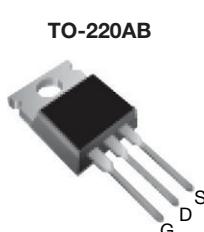


## E Series Power MOSFET

PRODUCT SUMMARY	
$V_{DS}$ (V) at $T_J$ max.	650
$R_{DS(on)}$ max. at 25 °C (Ω)	$V_{GS} = 10$ V 0.158
$Q_g$ max. (nC)	95
$Q_{gs}$ (nC)	16
$Q_{gd}$ (nC)	25
Configuration	Single



### ORDERING INFORMATION

Package	TO-220AB
Lead (Pb)-free and Halogen-free	SiHP23N60E-GE3

ABSOLUTE MAXIMUM RATINGS ( $T_C = 25$ °C, unless otherwise noted)			
PARAMETER	SYMBOL	LIMIT	UNIT
Drain-Source Voltage	$V_{DS}$	600	V
Gate-Source Voltage	$V_{GS}$	$\pm 30$	
Continuous Drain Current ( $T_J = 150$ °C)	$V_{GS}$ at 10 V	23	A
		15	
Pulsed Drain Current <sup>a</sup>	$I_{DM}$	63	
Linear Derating Factor		1.8	W/°C
Single Pulse Avalanche Energy <sup>b</sup>	$E_{AS}$	353	mJ
Maximum Power Dissipation	$P_D$	227	W
Operating Junction and Storage Temperature Range	$T_J, T_{stg}$	-55 to +150	°C
Drain-Source Voltage Slope	$T_J = 125$ °C	37	V/ns
Reverse Diode $dV/dt$ <sup>d</sup>		34	
Soldering Recommendations (Peak Temperature) <sup>c</sup>	for 10 s	300	°C

### Notes

- Repetitive rating; pulse width limited by maximum junction temperature.
- $V_{DD} = 50$  V, starting  $T_J = 25$  °C,  $L = 28.2$  mH,  $R_g = 25$  Ω,  $I_{AS} = 5$  A.
- 1.6 mm from case.
- $I_{SD} \leq I_D$ ,  $dI/dt = 100$  A/μs, starting  $T_J = 25$  °C.



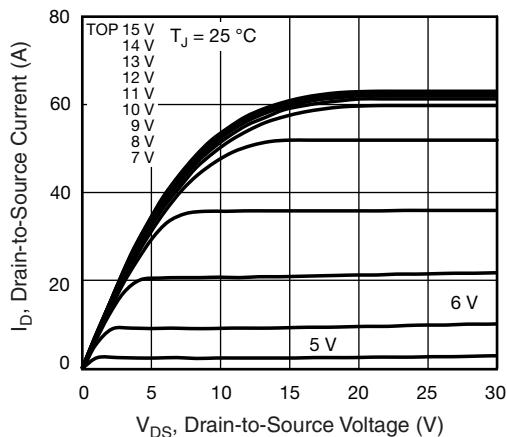
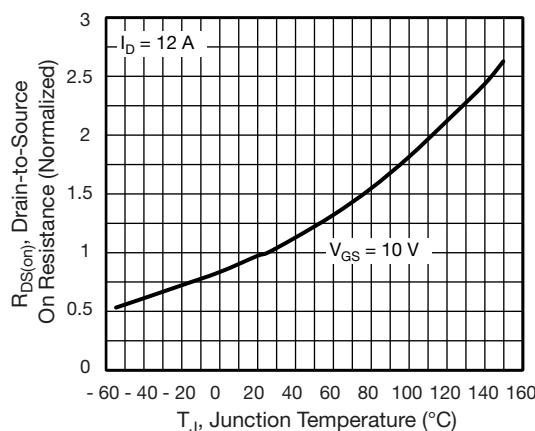
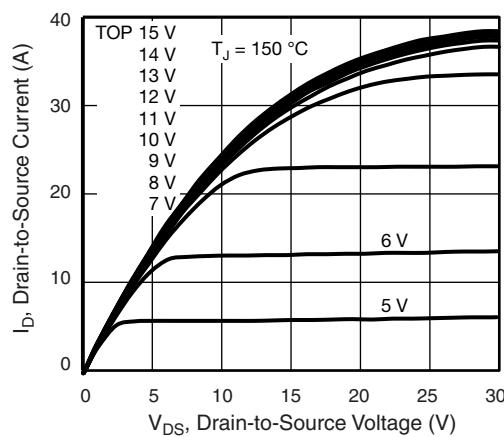
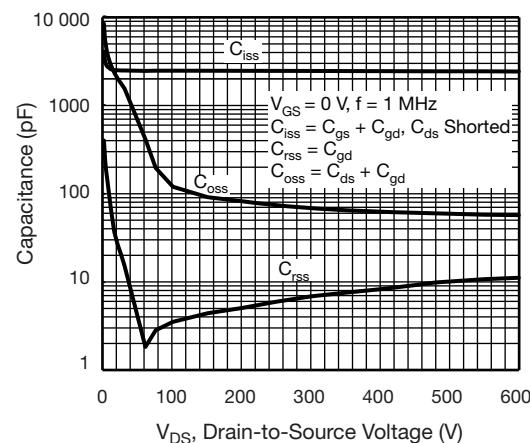
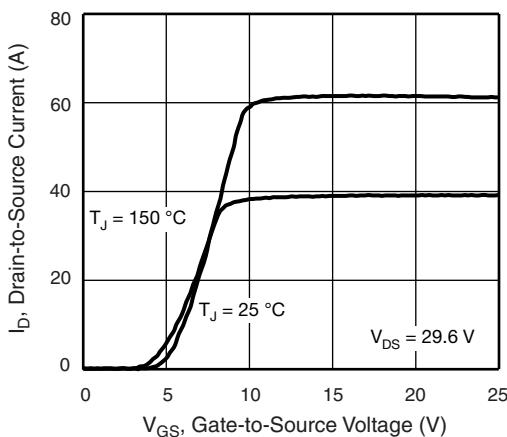
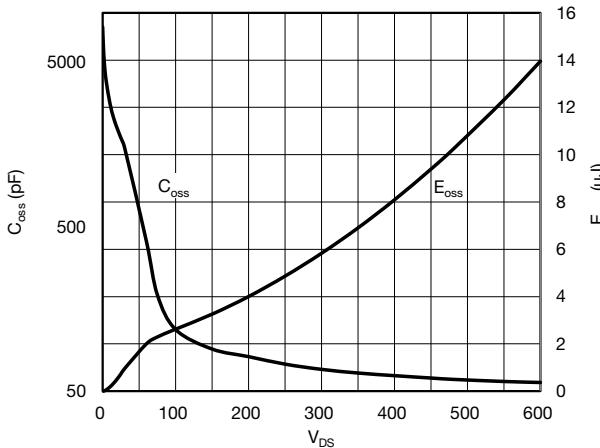
RoHS  
COMPLIANT  
HALOGEN  
FREE

<b>THERMAL RESISTACNE RATINGS</b>				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	$R_{thJA}$	-	62	
Maximum Junction-to-Case (Drain)	$R_{thJC}$	-	0.55	°C/W

<b>SPECIFICATIONS</b> ( $T_J = 25$ °C, unless otherwise noted)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
<b>Static</b>							
Drain-Source Breakdown Voltage	$V_{DS}$	$V_{GS} = 0$ V, $I_D = 250$ μA		600	-	-	V
$V_{DS}$ Temperature Coefficient	$\Delta V_{DS}/T_J$	Reference to 25 °C, $I_D = 1$ mA		-	0.72	-	V/°C
Gate-Source Threshold Voltage (N)	$V_{GS(th)}$	$V_{DS} = V_{GS}$ , $I_D = 250$ μA		2	-	4	V
Gate-Source Leakage	$I_{GSS}$	$V_{GS} = \pm 20$ V		-	-	± 100	nA
		$V_{GS} = \pm 30$ V		-	-	± 1	μA
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = 600$ V, $V_{GS} = 0$ V		-	-	1	
		$V_{DS} = 480$ V, $V_{GS} = 0$ V, $T_J = 125$ °C		-	-	10	μA
Drain-Source On-State Resistance	$R_{DS(on)}$	$V_{GS} = 10$ V	$I_D = 12$ A	-	0.132	0.158	Ω
Forward Transconductance	$g_{fs}$	$V_{DS} = 30$ V, $I_D = 12$ A		-	6.4	-	S
<b>Dynamic</b>							
Input Capacitance	$C_{iss}$	$V_{GS} = 0$ V, $V_{DS} = 100$ V, $f = 1$ MHz		-	2418	-	pF
Output Capacitance	$C_{oss}$			-	119	-	
Reverse Transfer Capacitance	$C_{rss}$			-	4	-	
Effective Output Capacitance, Energy Related <sup>a</sup>	$C_{o(er)}$	$V_{DS} = 0$ V to 480 V, $V_{GS} = 0$ V		-	107	-	
Effective Output Capacitance, Time Related <sup>b</sup>	$C_{o(tr)}$			-	320	-	
Total Gate Charge	$Q_g$			-	63	95	nC
Gate-Source Charge	$Q_{gs}$	$V_{GS} = 10$ V	$I_D = 12$ A, $V_{DS} = 480$ V	-	16	-	
Gate-Drain Charge	$Q_{gd}$			-	25	-	
Turn-On Delay Time	$t_{d(on)}$			-	22	44	ns
Rise Time	$t_r$	$V_{DD} = 480$ V, $I_D = 12$ A, $V_{GS} = 10$ V, $R_g = 9.1$ Ω		-	38	76	
Turn-Off Delay Time	$t_{d(off)}$		-	66	99		
Fall Time	$t_f$		-	34	68		
Gate Input Resistance	$R_g$	$f = 1$ MHz, open drain		-	0.73	-	Ω
<b>Drain-Source Body Diode Characteristics</b>							
Continuous Source-Drain Diode Current	$I_S$	MOSFET symbol showing the integral reverse p - n junction diode		-	-	23	A
Pulsed Diode Forward Current	$I_{SM}$			-	-	63	
Diode Forward Voltage	$V_{SD}$	$T_J = 25$ °C, $I_S = 12$ A, $V_{GS} = 0$ V		-	0.9	1.2	V
Reverse Recovery Time	$t_{rr}$	$T_J = 25$ °C, $I_F = I_S = 12$ A, $dI/dt = 100$ A/μs, $V_R = 25$ V		-	384	768	ns
Reverse Recovery Charge	$Q_{rr}$			-	6.4	12.8	μC
Reverse Recovery Current	$I_{RRM}$			-	30	-	A

**Notes**

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ .  
b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ .

**TYPICAL CHARACTERISTICS** (25 °C, unless otherwise noted)

**Fig. 1 - Typical Output Characteristics**

**Fig. 4 - Normalized On-Resistance vs. Temperature**

**Fig. 2 - Typical Output Characteristics**

**Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage**

**Fig. 3 - Typical Transfer Characteristics**

**Fig. 6 -  $C_{oss}$  and  $E_{oss}$  vs.  $V_{DS}$**

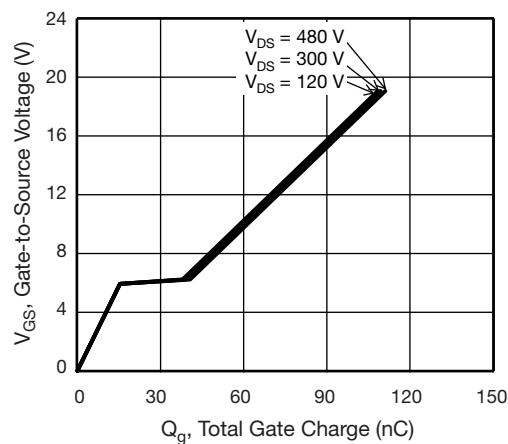


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

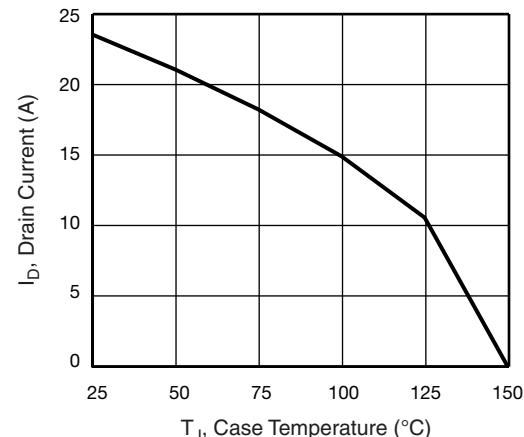


Fig. 10 - Maximum Drain Current vs. Case Temperature

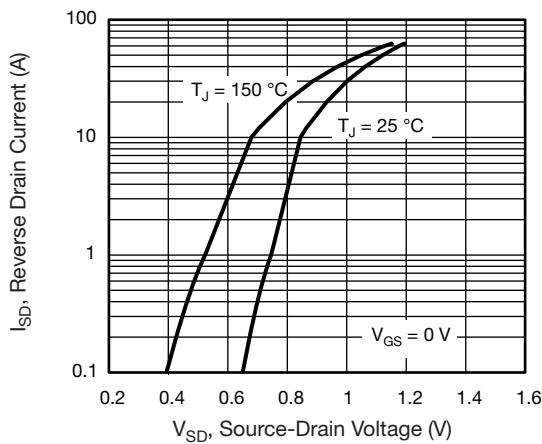


Fig. 8 - Typical Source-Drain Diode Forward Voltage

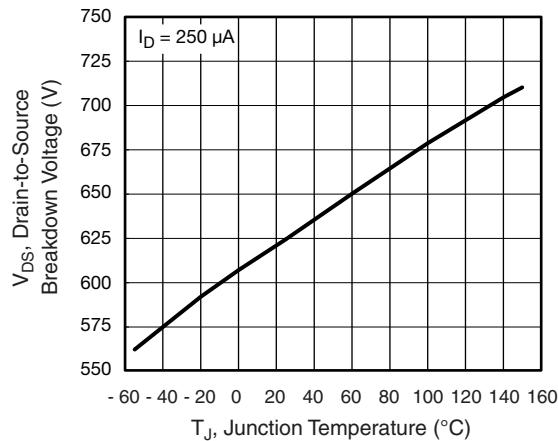


Fig. 11 - Temperature vs. Drain-to-Source Voltage

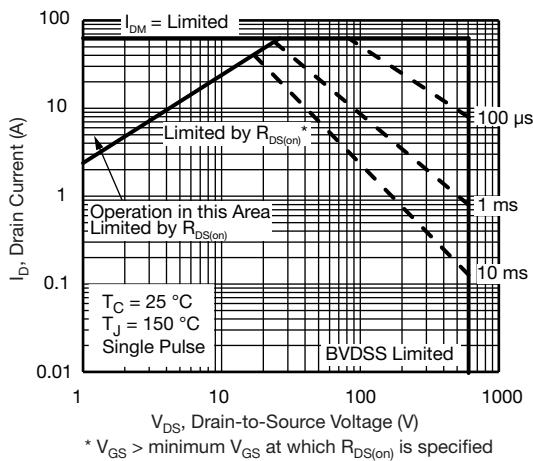
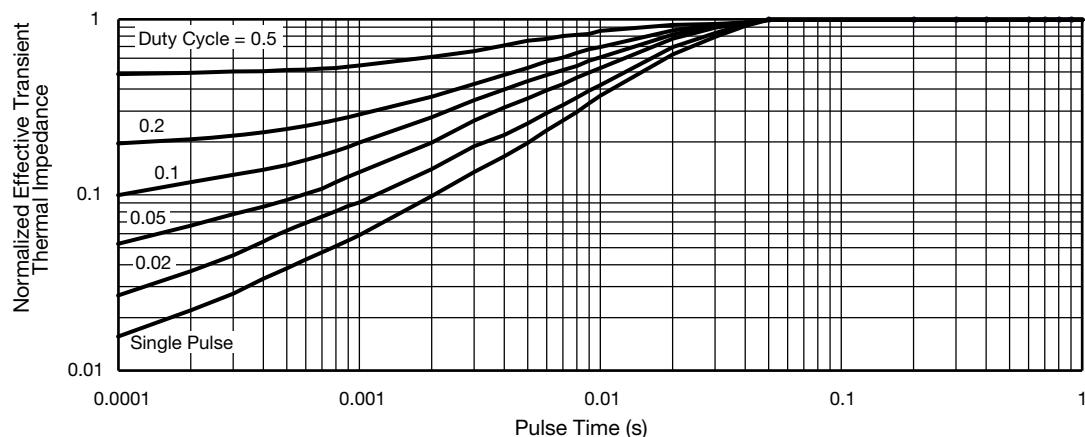
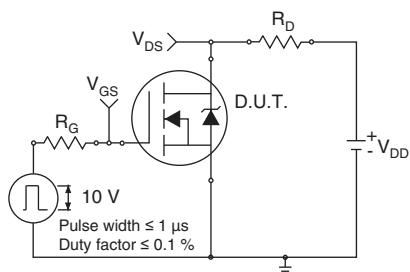


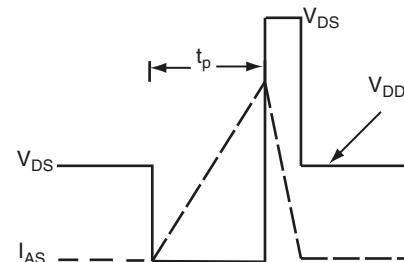
Fig. 9 - Maximum Safe Operating Area



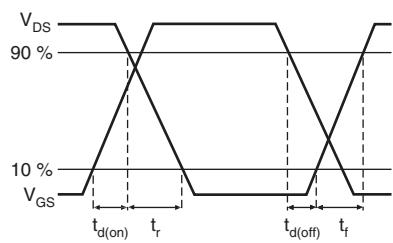
**Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case**



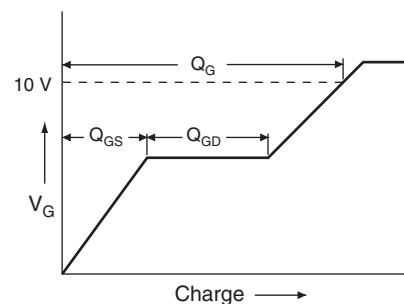
**Fig. 13 - Switching Time Test Circuit**



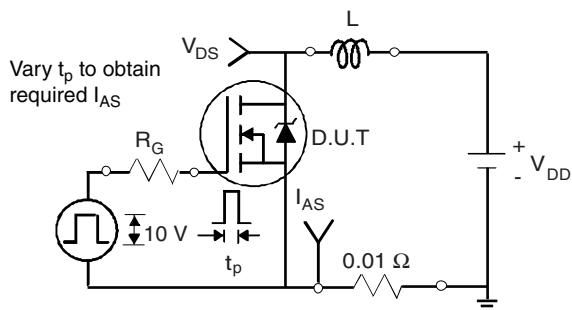
**Fig. 16 - Unclamped Inductive Waveforms**



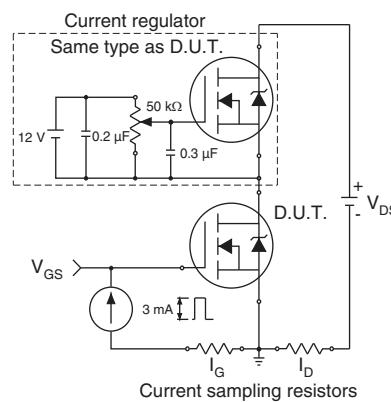
**Fig. 14 - Switching Time Waveforms**



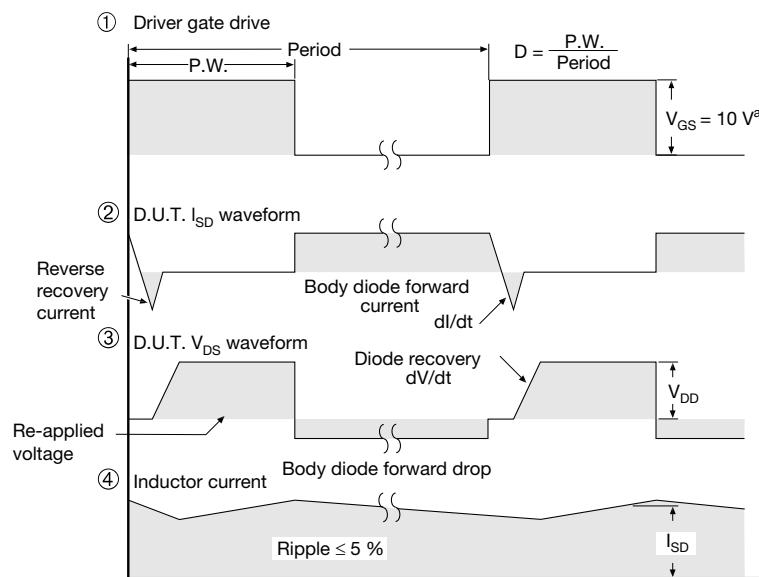
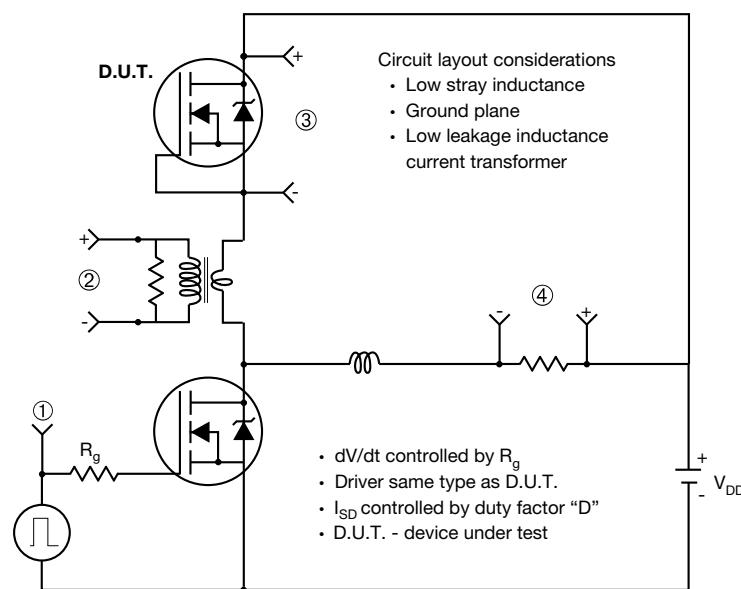
**Fig. 17 - Basic Gate Charge Waveform**



**Fig. 15 - Unclamped Inductive Test Circuit**



**Fig. 18 - Gate Charge Test Circuit**

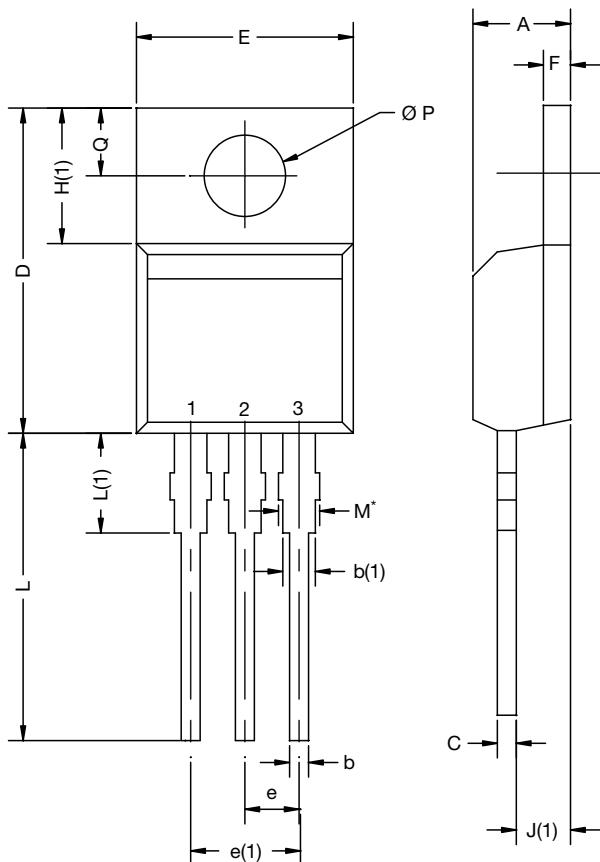
**Peak Diode Recovery dV/dt Test Circuit**

**Note**

a.  $V_{GS} = 5 V$  for logic level devices

**Fig. 19 - For N-Channel**

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### TO-220-1



DIM.	MILLIMETERS		INCHES	
	MIN.	MAX.	MIN.	MAX.
A	4.24	4.65	0.167	0.183
b	0.69	1.02	0.027	0.040
b(1)	1.14	1.78	0.045	0.070
c	0.36	0.61	0.014	0.024
D	14.33	15.85	0.564	0.624
E	9.96	10.52	0.392	0.414
e	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	1.14	1.40	0.045	0.055
H(1)	6.10	6.71	0.240	0.264
J(1)	2.41	2.92	0.095	0.115
L	13.36	14.40	0.526	0.567
L(1)	3.33	4.04	0.131	0.159
Ø P	3.53	3.94	0.139	0.155
Q	2.54	3.00	0.100	0.118

ECN: X15-0364-Rev. C, 14-Dec-15  
DWG: 6031

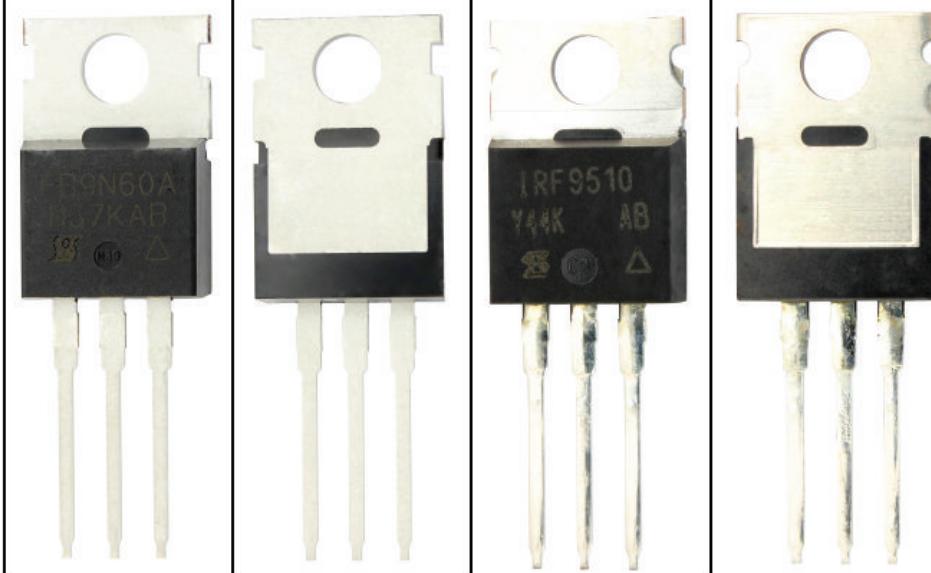
#### Note

- $M^* = 0.052$  inches to  $0.064$  inches (dimension including protrusion), heatsink hole for HVM

Package Picture

ASE

Xi'an



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